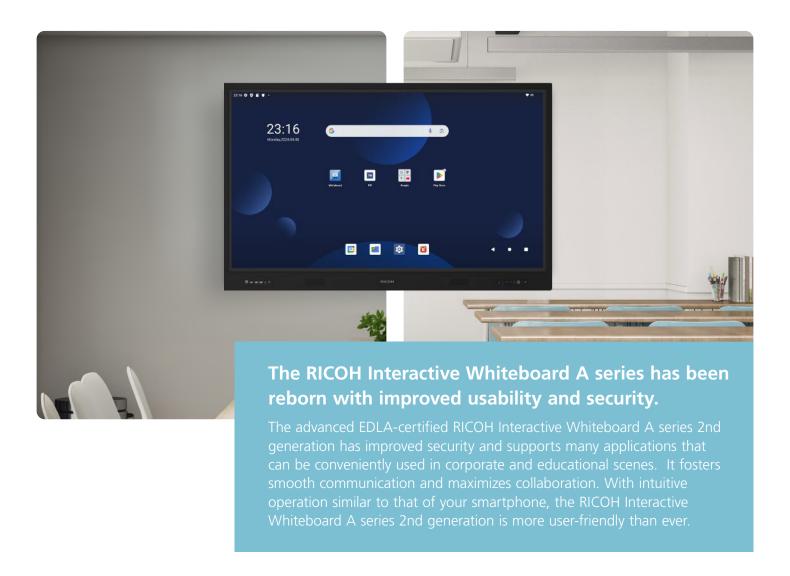
## RICOH Interactive Whiteboard

A6510 A7510 A8610









#### **RICOH Interactive Whiteboard A series 2nd generation**





#### **Key features**

- Embedded Android and Google EDLA certified.
- Expandable with Windows controllers.
- Wirelessly connect to PCs and peripherals at hand.
- As a starting point for communication, type in your idea instantly and share on the fly.

# 3

#### **Powerful and Feature-Rich Hardware Design**



#### **EDLA** certified

Google Mobile Service (GMS) is available and comes pre-installed with useful Google applications, including Google Chrome and others. Google Play Protect also ensures that apps and devices are secure.



#### **User comfort**

Blue light cut function reduces eye fatigue. The anti-fingerprint finish on the screen surface resists fingerprints and smudges, and if smudges do stick, they can be removed with a light wipe.



#### Large RAM/ROM

Peak performance with 8GB of RAM and 128GB of ROM for fast response and stable operation.



## 40-point multi-touch functionality with a smooth and comfortable operation

Up to 40 simultaneous touch points enable more active collaboration with multiple people writing at the same time. It can work seamlessly with the major operating systems including Windows, Android, Linux, Mac, and Chrome.





#### Versatile connectivity with a frontfacing interface

Supports a range of interfaces such as HDMI, USB, Microphone and the latest USB Type-C. The interface ports are mounted on the front of the IWB to make it easy to connect an external device.



#### **Connect wirelessly**

Supports Bluetooth (5.2) for wireless connection to audio and other devices. It also supports the latest Wi-Fi6 for high-speed communication.



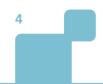
#### Powerful audio

Equipped with a pair of 15W speakers for clear high-definition audio.



#### **ENERGY STAR®** certifiedt

This is an environmentally-friendly ENERGY STAR certified product.



#### **Plug and Play Android Apps**

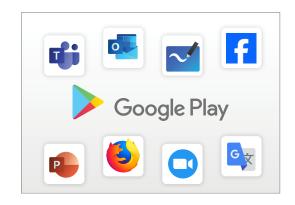
#### **Useful pre-installed applications**

The embedded Android OS allows you to use a wide range of pre-installed applications such as whiteboard and wireless presentation applications right out of the box. Apps are easily accessible from a list screen and can also be managed in folders for each purpose.





Users have direct access to the Google Play store and can install a variety of applications depending on their usage scenario.



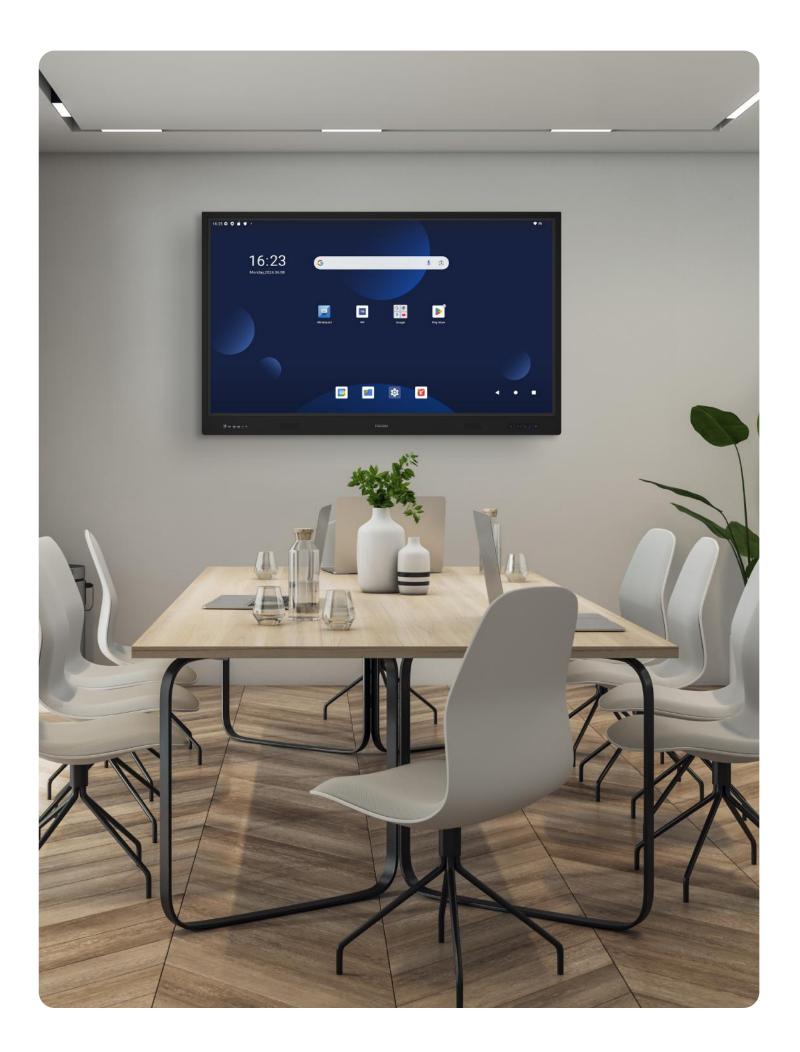


#### Seamless wireless presentation and collaboration EShare

You can perform wireless screencasting from any OS, such as Windows, iOS, Mac, Android, Chrome and Ubuntu. Make your meetings and classes even more efficient thanks to the ability to display up to four screens at once. Operation of PCs is also available from IWB wirelessly.









#### Easy-to-use digital whiteboard

#### **Whiteboard**

The digital whiteboard is an excellent tool to maximize collaboration at meetings and classes. When the meeting or class is over, you can save the contents to the cloud for future sharing.





















#### **Floating Toolbar**

A toolbar with pen and eraser functions and the ability to insert shapes. The handwriting text conversion and handwriting shape conversion functions allow you to convert handwritten text to digital and handwritten shapes to digital. Once converted to text or shapes, size, color, and placement can also be converted.

#### **Option Box**

Includes useful classroom and meeting tools such as rulers, sticky notes, mind maps, PDFs, and table inserts. It also includes web search, YouTube viewing, and split-screen capabilities for active collaboration in classrooms and meetings.

#### **Navigation Bar**

You can move, add and delete pages, and add up to 299 pages. Various templates are also available, such as background color change, sheet music, soccer court, and so on.



#### Easier information sharing

#### **Picture in Picture**

External video input can be displayed separately on a small screen in a portion of the screen. This allows you to review multiple pieces of information at the same time, enabling efficient information sharing in various situations such as meetings, classes, and presentations.

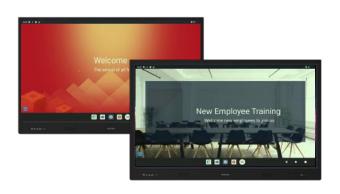




Effectively communicate information on a large screen

#### **Signage**

Text information, images, and videos can be inserted and displayed on the screen based on a template. In addition to use as a welcome board, information can be displayed on a large screen, making it useful for communicating information at events and during emergencies.

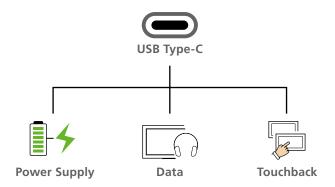


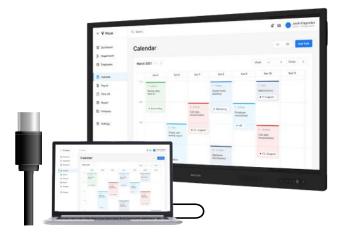


#### **Flexible Functions and Solutions**

### Frustration-free user experience with USB Type-C connection

The included USB Type-C cable allows you to simultaneously send images, pass along touch controls, and supply power to the device all with a single cable. By simply plugging in, you can freely perform operations on your PC directly from the IWB.





#### Overlay annotation and smooth capture

The embedded annotation tool allows you to annotate on any displayed image. You can easily capture annotations on a displayed image and then paste the image onto the whiteboard. This can then be saved as the meeting minutes after finishing discussions.

#### **Overlay Annotation**







#### Customizing the IWB by user account

Log in with the account you added to the IWB to access the personal environment you set up. If the IWB is shared by multiple users, different accounts can improve usability and prevent data confusion. You can add up to 25 accounts.





## **Various Use Scenes**

#### When you need it, where you need it, more convenience with the Floating Bar

The Floating Bar is an innovative feature that accelerates user interaction when using IWB. The ball can be moved anywhere on the screen, and the user can show or hide it as needed. In addition, a long press allows users to customize their own shortcuts for frequently used operations.











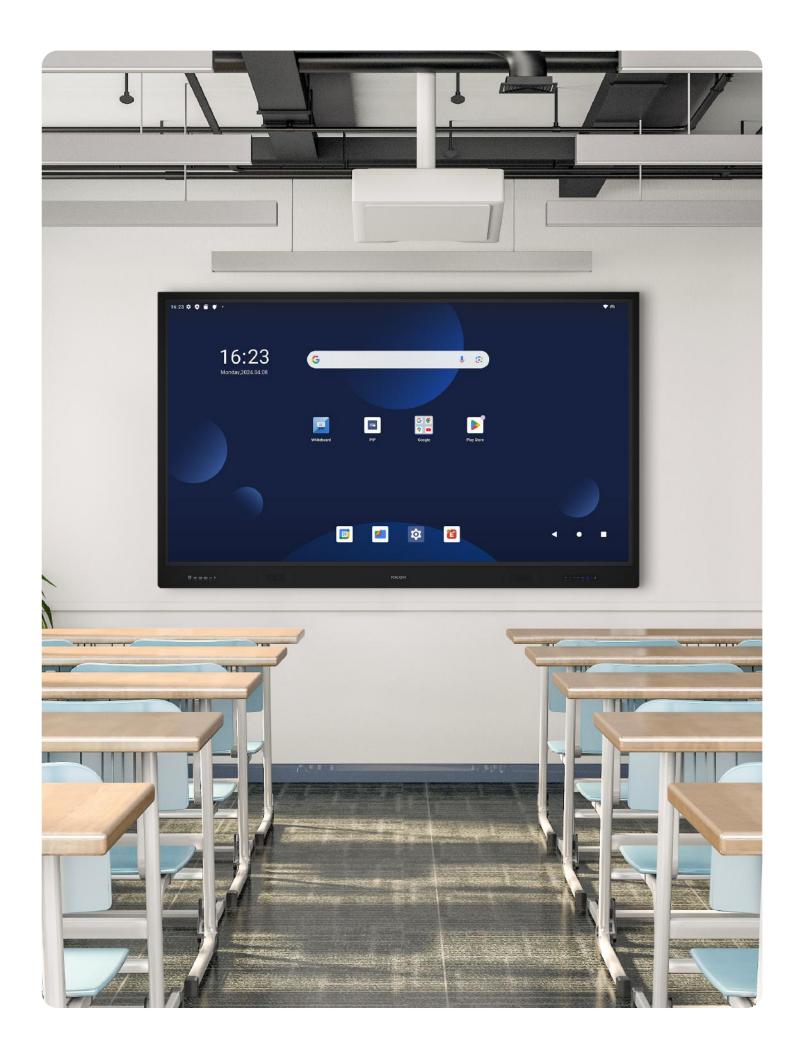
#### **OPTION**



#### \*This is an image picture

#### **RICOH IWB Software Suite for Windows**

annotation, whiteboard and wireless projection





## INTERACTIVE FLAT PANEL DISPLAYS A6510 A7510 A8610 MAIN SPECIFICATIONS

	ITEMS	A6510	A7510	A8610			
LCD Panel	Diagonal Screen Size	65 inch	75 inch	86 inch			
	Display Type	VA(HVA)	VA(HVA)	VA(AMVA3)			
	Orientation		Landscape				
	Backlight	Direct LED, flicker free (DC Dimming)  3,840 x 2,160(4K)  1,07 Billion					
	Resolution						
	Color						
	Brightness		400cd/m2				
	Aspect Ratio		16:9				
	Contrast Ratio	5000:1 (typ.)	5500:1 (typ.)	4000:1 (typ.)			
	Pixel Pitch			(** /			
	Response Speed	0.124mm(H)x 0.372mm(V)	0.14325mm(H)x 0.42975mm(V)	0.4935mm(H)x 0.4935mm(V)			
	View Area	typ 6.5ms Panel Spec.	typ 6.5ms X Panel Spec.	typ 8ms X Panel Spec.			
		1,428mm(H) X 803 mm(V)	1,650mm(H) X 928 mm(V)	1,895mm(H) X 1,065 mm(V)			
	Viewing Angle		178° (H)/178° (V) (typ.) Panel Spec.				
	Refreshing Frequency		60Hz				
	LED Life time		50,000hrs (typ)				
Cover glass	Thickness Coating		3.2mm 0.2mm				
	•		Pre-treated AG (Anti-glare), AF (Anti-fingerprin	it)			
	Hardness	8H(Pencil hardness)					
Touch	Technology Maximum Touch Points	Infrared Touch Frame Zero Bonding					
	Positional Accuracy	40					
	•		+ 1mm				
	os Environment	Win11/10/8/7/XP, Android, Linux, Mac os X,	, Chrome, Linux test version: Ubuntu Kylin 18.04.1 I	_TS Mac test version: 10.14. Chrome test version			
	Touch pen request	73.0.3683.114(64-bit)					
	Interpolation Resolution	Peri	tip (thin): 2.8mm in diameter Pen tip (thick): 10mm	in diameter			
	Touch output/Connect Type		32768x32768				
	rouch output/connect Type	USB2.0					
nferface	Front Interface Side Interface	USB C in (Full/PD65W) x1, USB A 3.0 Publicx2, USB B 3.0 (TOUCH) x1 HDMI 2.0 in x1, MIC In x1 USB Type-A (3.0, Public) x2, USB Type-C (Full/PD15W) x1, USB Type-B 3,0 (TOUCH) x3 Slot x1 HDMI 2.0 in x2, DisplayPort 1.2 in x1, OPS RS232 x1, Audio-out x1, Line out or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USB A 3.0 for Android x1, LAN 1000Base-T					
	Bottom Interface	RS232 x1, Audio-out x1, Line out					
tructure			or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE	3 A 3.0 for Android x1, LAN 1000Base-T			
tructure	Dimensions	1,512.9 mmx 952.8mm x 92.5 mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE 1,735.1mm x 1,077.3mm x 92.4 mm	3 A 3.0 for Android x1, LAN 1000Base-T 1,981mm x 1,217m x 92.2 mm			
tructure	Dimensions Weight		or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE	3 A 3.0 for Android x1, LAN 1000Base-T			
tructure	Dimensions Weight Housing Material (Face frame/	1,512.9 mmx 952.8mm x 92.5 mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE 1,735.1mm x 1,077.3mm x 92.4 mm	3 A 3.0 for Android x1, LAN 1000Base-T 1,981mm x 1,217m x 92.2 mm			
tructure	Dimensions Weight Housing Material (Face frame/Back shell)	1,512.9 mmx 952.8mm x 92.5 mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate	3 A 3.0 for Android x1, LAN 1000Base-T 1,981mm x 1,217m x 92.2 mm			
tructure	Dimensions Weight Housing Material (Face frame/	1,512.9 mmx 952.8mm x 92.5 mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE 1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg	3 A 3.0 for Android x1, LAN 1000Base-T 1,981mm x 1,217m x 92.2 mm			
tructure	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/	1,512.9 mmx 952.8mm x 92.5 mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate	3 A 3.0 for Android x1, LAN 1000Base-T 1,981mm x 1,217m x 92.2 mm			
tructure	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell)	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate  Black/Black	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg			
tructure	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell) VESA	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate  Black/Black  VESA: 4-M8 Screw Hole 800mmx400mm	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg			
tructure	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell) VESA Speakers	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate  Black/Black  VESA: 4-M8 Screw Hole 800mmx400mm  15W x 2	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm  65kg±3kg			
	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell) VESA Speakers Dust Resistant	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate  Black/Black  VESA: 4-M8 Screw Hole 800mmx400mm  15W x 2	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg			
	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell) VESA Speakers Dust Resistant	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm  52kg ±3kg  Aluminum/Metal plate  Black/Black  VESA: 4-M8 Screw Hole 800mmx400mm  15W x 2  No	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm  65kg±3kg			
	Dimensions Weight Housing Material (Face frame/ Back shell) Housing Color (Face frame/ Back shell) VESA Speakers Dust Resistant  OS RAM	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg			
	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage)	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm			
	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm			
	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage)	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm			
	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm	or Headphone x1, SPDIF x1, HDMI 2.0 out x1 USE  1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg  Aluminum/Metal plate  Black/Black  VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2  No  Android 13.0 EDLA 8GB 128GB  Cortex-A73*4core + Cortex-A53*4core / Amlogic A	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  311D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module:-			
TL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm  IEEE802.11a/b/g/n/ac/ax Bluetooth B	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  311D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : -			
TL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm  IEEE802.11a/b/g/n/ac/ax Bluetooth B	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1	1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  311D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : - 11ac  DHz, EU/AP: 50Hz)			
TL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface  Power Source Power Consumption Power Consumption without	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm  IEEE802.11a/b/g/n/ac/ax Bluetooth B	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1 0V(NA: 120V, EU/AP: 220~240V) 50/60Hz(NA: 60420W	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  311D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : -			
TL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface  Power Source Power Consumption Power Consumption without OPS *Typical Power Consumption without	1,512.9 mmx 952.8mm x 92.5 mm	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1 0V(NA: 120V, EU/AP: 220~240V) 50/60Hz(NA: 60420W <200W	3 A 3.0 for Android x1, LAN 1000Base-T  1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  811D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : - 1 11ac  DHz, EU/AP: 50Hz) 520W			
TL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface  Power Source Power Consumption Power Consumption without OPS *Typical Power Consumption without OPS *Eco mode	1,512.9 mmx 952.8mm x 92.5 mm 40kg±3kg  VESA: 4-M8 Screw Hole 600mmx400mm  IEEE802.11a/b/g/n/ac/ax Bluetooth B	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1 0V(NA: 120V, EU/AP: 220~240V) 50/60Hz(NA: 60420W <200W <150W	1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  811D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : - 1 11ac  OHz, EU/AP: 50Hz)  520W			
etructure	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface  Power Source Power Consumption Power Consumption without OPS *Typical Power Consumption without OPS *Eco mode Power Consumption (Standby)	1,512.9 mmx 952.8mm x 92.5 mm	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1 0V(NA: 120V, EU/AP: 220~240V) 50/60Hz(NA: 60420W <200W	1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  811D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : - 1 11ac  OHz, EU/AP: 50Hz)  520W			
ïΤL	Dimensions Weight Housing Material (Face frame/Back shell) Housing Color (Face frame/Back shell) VESA Speakers Dust Resistant  OS RAM ROM(Storage) CPU/Chipest GPU Wireless Inferface  Power Source Power Consumption Power Consumption without OPS *Typical Power Consumption without OPS *Eco mode	1,512.9 mmx 952.8mm x 92.5 mm	1,735.1mm x 1,077.3mm x 92.4 mm 52kg ±3kg Aluminum/Metal plate Black/Black VESA: 4-M8 Screw Hole 800mmx400mm 15W x 2 No  Android 13.0 EDLA 8GB 128GB Cortex-A73*4core + Cortex-A53*4core / Amlogic A: Mali G52 MP8 (8EE) T5.2 Wifi6 Module: 574Mbps@2.4GHz 2*2 11ax - 150Mbps@2.4GHz 1*1 11n - 433Mbps@5GHz 1*1 0V(NA: 120V, EU/AP: 220~240V) 50/60Hz(NA: 60420W <200W <150W	1,981mm x 1,217m x 92.2 mm 65kg±3kg  VESA: 4-M8 Screw Hole 800mmx400mm  811D2  1204Mbps@5GHz 2*2 11ax Wifi5 Module : - 1 11ac  OHz, EU/AP: 50Hz)  520W			
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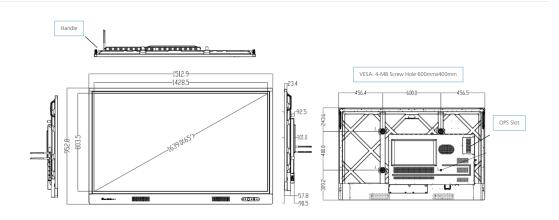


### INTERACTIVE FLAT PANEL DISPLAYS A6510 A7510 A8610 MAIN SPECIFICATIONS

CATEGORY	ITEMS	A6510	A7510	A8610		
Usage conditions	Operating temperature	0°C 40°C (32° F 104° F), Standard temperature : 23°C				
	Operating humidity	20-80% RH Non-Condensing, Standard humidity : 50%				
	Operating altitude	0~5,000m				
	Maximum daily operation hours(- exclude stand-by time)	18 hours/day (24 hours) * * Do not use the machine continuously / cause display malfunction. Manually switch and/or [Energy Conservation] to power off intermittently for more than 18 hours per day. to Sleep mode when the machine is not the display. Exceeding maximum operating hours may being used. You can also set [Auto Standby]  No				
	Environmental sensor					
Storage conditions	Storage temperature Storage humidity	-10°C-50°C	-10°C-50°C	-10°C-50°C		
		15%RH-80% RH	15%RH-80% RH	15%RH-80% RH		
	Shelf life	14 months (*After manufacturing)				

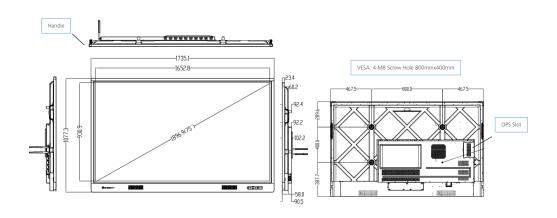
#### Design A6510

VESA: 4-M8 Screw Hole 600mmx400mm



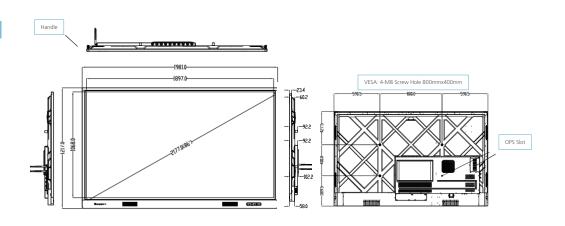
#### Design A7510

VESA: 4-M8 Screw Hole 800mmx400mm



#### Design A8610

VESA: 4-M8 Screw Hole 800mmx600mr



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